



#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub>	Package	Ι <sub>D</sub> T <sub>A</sub> = +25°C
60V	8Ω @ V <sub>GS</sub> = 5V	SOT363	170mA
60 V	6Ω @ V <sub>GS</sub> = 10V	501363	200mA

### Description

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

# Applications

- **DC-DC** Converters
- **Power Management Functions**
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories. Transistors. etc.

#### Features

- **Dual N-Channel MOSFET**
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate, 1KV (HBM)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### Mechanical Data

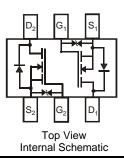
- Case: SOT363
- Case Material: Molded Plastic; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 (e3)
- Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe).
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)



ROTECTED TO 1kV

Top View

SOT363



#### Ordering Information (Note 5)

ESD P

Part Number	Case	Packaging
DMN65D8LDWQ-7	SOT363	3,000/Tape & Reel

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_grade\_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

	SOT363					
MM1 YM						
	MY 1MM					

MM1= Product Type Marking Code YM = Date Code Marking

Y = Year (ex: A = 2013)

M = Month (ex: 9 = September)

Date	Code	Kev
Dale	Coue	rtey

Year	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017	2018
Code	U	V	W	Х	Y	Z	А	В	С	D	E	F
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

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## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Character	Symbol	Value	Units		
Drain-Source Voltage			V <sub>DSS</sub>	60	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current (Note 6) V <sub>GS</sub> =10	V Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	180 140	mA
Continuous Drain Current (Note 6) $V_{GS} = 5$	/ Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	150 120	mA
Continuous Drain Current (Note 7) $V_{GS} = 10$	OV Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	200 160	mA
Continuous Drain Current (Note 7) $V_{GS} = 5$	/ Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	170 140	mA
Pulsed Drain Current (10µs pulse, duty cycle = 19	%)		I <sub>DM</sub>	800	mA

### **Thermal Characteristics**

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 6)	PD	300	mW
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>θJA</sub>	435	°C/W
Total Power Dissipation (Note 7)	PD	400	mW
Thermal Resistance, Junction to Ambient (Note 7)	R <sub>θJA</sub>	330	°C/W
Thermal Resistance, Junction to Case (Note 7)	R <sub>θJC</sub>	139	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	C°

#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

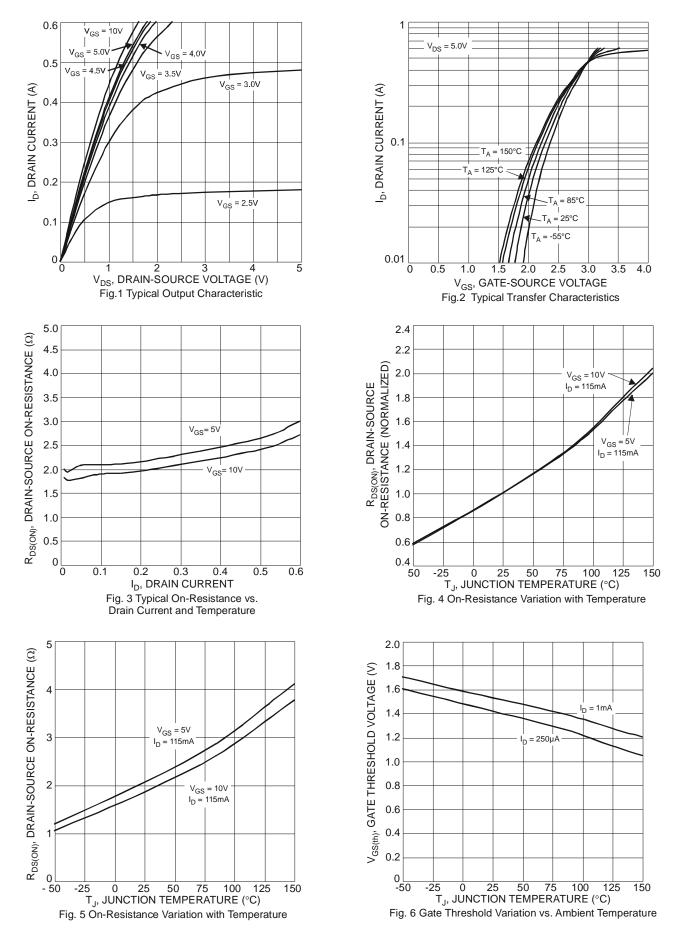
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60			V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current $T_J = +25^{\circ}C$ $T_J = +125^{\circ}C$ (Note 8)	I <sub>DSS</sub>		_	1.0 5.0	μA	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Body Leakage	I <sub>GSS</sub>			±5.0	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						·
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0		2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance				8	Ω	V <sub>GS</sub> = 5.0V, I <sub>D</sub> = 0.115A
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)			6	Ω	V <sub>GS</sub> = 10.0V, I <sub>D</sub> = 0.115A
Forward Transconductance	<b>g</b> fs	80	_		mS	V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.115A
Diode Forward Voltage	V <sub>SD</sub>	—	0.8	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA
DYNAMIC CHARACTERISTICS (Note 9)					•	·
Input Capacitance	Ciss		22.0			
Output Capacitance	Coss		3.2		рF	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$
Reverse Transfer Capacitance	Crss		2.0			
Gate Resistance	$R_{G}$		79.9		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge V <sub>GS</sub> = 10V	Qg		0.87			
Total Gate Charge V <sub>GS</sub> = 4.5V	Qg		0.43		nC	$V_{GS} = 10V, V_{DS} = 30V,$
Gate-Source Charge	Q <sub>gs</sub>		0.11		nc	I <sub>D</sub> = 150mA
Gate-Drain Charge	Q <sub>gd</sub>		0.11			
Turn-On Delay Time	t <sub>D(on)</sub>		3.3			
Turn-On Rise Time	tr		3.2		nS	V <sub>DD</sub> = 30V, I <sub>D</sub> = 0.115A, V <sub>GEN</sub> = 10V,
Turn-Off Delay Time	t <sub>D(off)</sub>		12.0		113	$R_{GEN} = 25\Omega$
Turn-Off Fall Time	t <sub>f</sub>		6.3		1	

Notes: 6. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

Bevice mounted on FR-4 substrate PC board, with minimum recommended pad rayout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper pad layout
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.



# DMN65D8LDWQ



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# DMN65D8LDWQ

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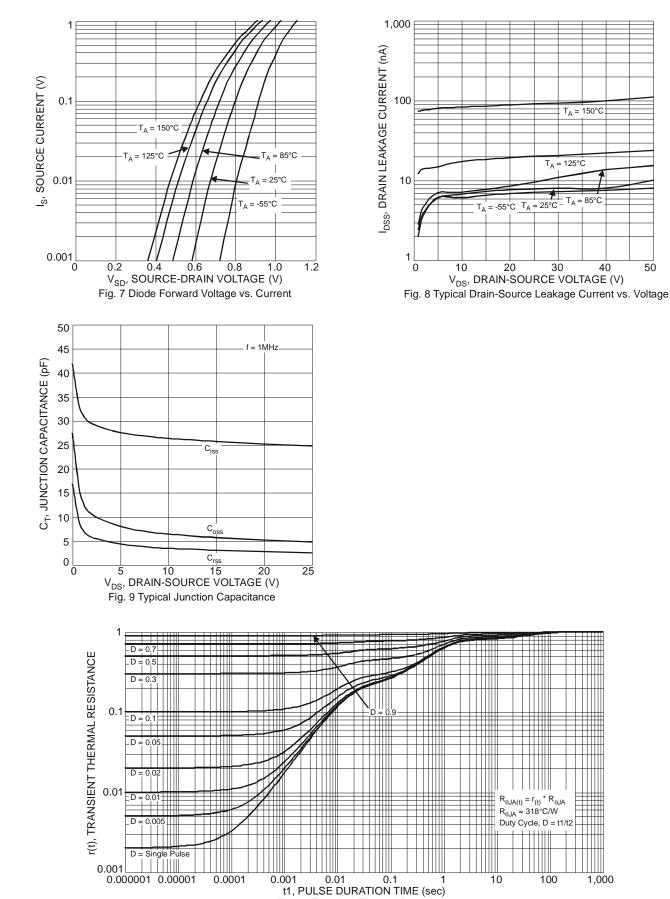


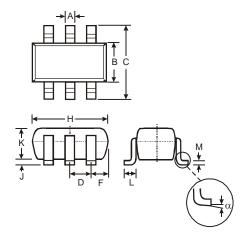
Fig. 10 Transient Thermal Resistance

1,000



# Package Outline Dimensions

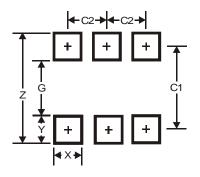
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT363								
Dim	Min	Max	Тур						
A	0.10	0.30	0.25						
В	1.15 1.35 1.30								
С	2.00	2.00 2.20 2.10							
D		0.65 Ty	р						
F	0.40	0.45	0.425						
Η	1.80	2.20	2.15						
J	0	0.10	0.05						
Κ	0.90	1.00	1.00						
L	0.25	0.40	0.30						
М	0.10	0.22	0.11						
α	0°	8°	-						
All	Dimen	isions i	n mm						

## Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65



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